January 2001



Si4874DY

Single N-Channel, Logic Level, PowerTrench MOSFET

General Description

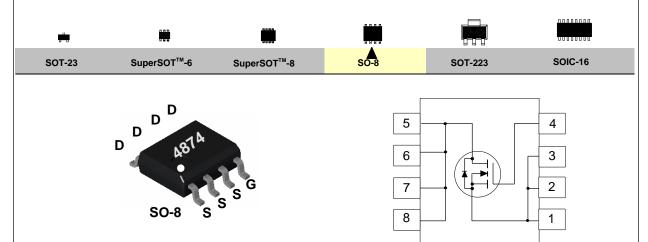
FAIRCHILE

This N-Channel Logic Level MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- Fast switching speed.
- Low gate charge (35 nC typical).
- High performance trench technology for extremely low R_{DS(ON)}.
- High power and current handling capability.



Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless other wise noted

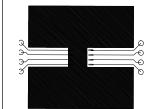
Symbol	Parameter	Si4874DY	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±20	V
D	Drain Current - Continuous (Note 1a)	13	А
	- Pulsed	50	
P _D	Power Dissipation for Single Operation (Note 1a)	2.5	W
	(Note 1b)	1.2	
	(Note 1c)	1	
Г _. ,Т _{stg}	Operating and Storage Temperature Range	-55 to 150	°C
THERMA	L CHARACTERISTICS		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	50	°C/W
R _{ejic}	Thermal Resistance, Junction-to-Case (Note 1)	25	°C/W

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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to	o 25 ℃		20		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$				1	μA
			T _J = 55°C			10	μA
IGSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
IGSSR	Gate - Body Leakage, Reverse	V _{GS} = -20 V, V _{DS} = 0 V				-100	nA
	CTERISTICS (Note 2)						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_{D} = 250 µA, Referenced to	o 25 ℃		-4.5		mV /ºC
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 13 \text{ A}$			0.0063	0.0075	Ω
			T_ =125°C		0.009	0.014	
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10.5 \text{ A}$			0.0082	0.01	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$		50			А
9 _{FS}	Forward Transconductance	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 13 \text{ A}$			50		S
DYNAMIC C	HARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			3200		pF
C _{oss}	Output Capacitance				820		pF
C _{rss}	Reverse Transfer Capacitance				400		pF
SWITCHING	CHARACTERISTICS (Note 2)	·					
t _{D(on)}	Turn - On Delay Time	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ A}$			15	27	ns
t,	Turn - On Rise Time	$V_{GS} = 10 \text{ V}$, $R_{GEN} = 6 \Omega$			15	27	ns
t _{D(off)}	Turn - Off Delay Time				85	105	ns
t,	Turn - Off Fall Time				42	68	ns
Q _g	Total Gate Charge	$V_{\rm DS} = 15 \text{ V}, \ \text{I}_{\rm D} = 13 \text{ A},$			35	50	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 5 V$			9		nC
Q _{gd}	Gate-Drain Charge				16		nC
DRAIN-SOU	RCE DIODE CHARACTERISTICS AND MAXIM	IUM RATINGS		•	•		
I _s	Maximum Continuous Drain-Source Diode Forward Current					2.1	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2.1 A$ (Note 2)			0.71	1.2	V

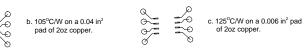
Notes:

1. R_{auk} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{auc} is guaranteed by design while $\mathrm{R}_{_{\mathrm{\theta}\mathrm{CA}}}$ is determined by the user's board design.



a. 50°C/W on a 1 in² pad of 2oz copper.

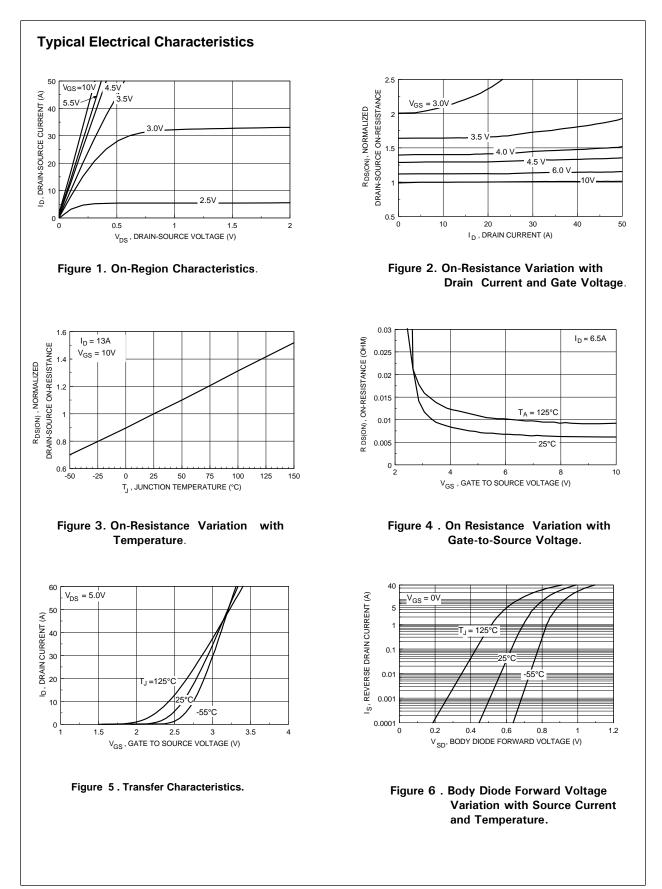


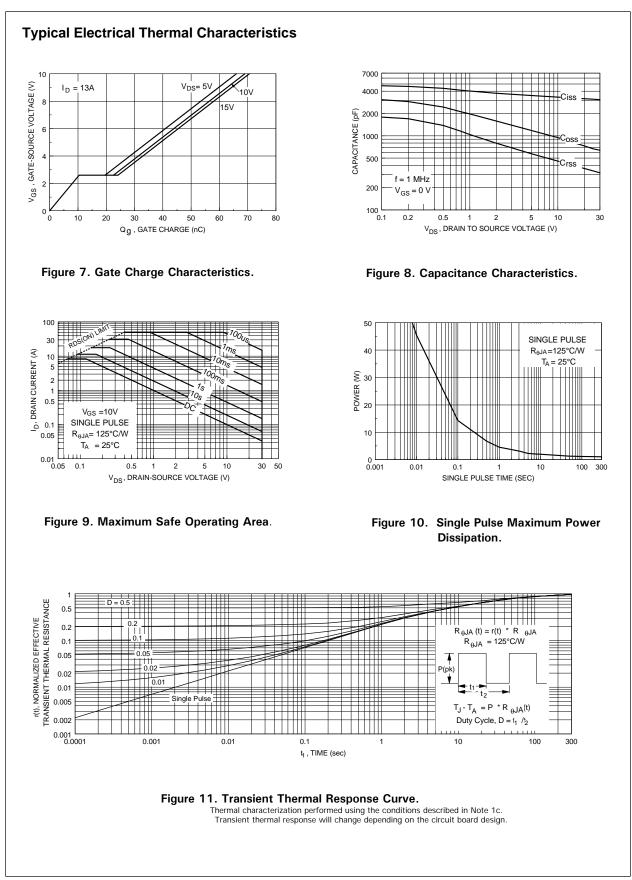




Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.





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